AMENDMENT UNDER 37 C.F.R. § 1.111 Attorney Docket No.: Q80165

Application No.: 10/589,611

AMENDMENTS TO THE DRAWINGS

In response to the drawing objection, a replacement drawing sheet (Figure 2) is submitted

herewith to show a contact metal layer 11, a positive-electrode-metal-containing layer 6, and a

semiconductor-metal-containing layer 7.

Due to addition of the replacement drawing sheet of Figure 2, replacement sheets for

Figures 1 and 3-7 are necessary and submitted herewith solely for the purpose of labeling the

drawings with correct pagination (i.e., changing the drawing sheet pagination from "1/6-6/6" to

"1/7-7/7").

Attachments: Six (6) Annotated Sheets (Figs. 1-7)

Seven (7) Replacement Drawing Sheet (Figs. 1-7)

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REMARKS

Upon entry of the Amendment, claims 1-7 and 9-16 will be all the claims pending in the

application. Claims 1 and 9-11 have been amended. Claim 8 has been canceled. Claim 16 is

withdrawn from consideration as being directed to a non-elected invention.

Claim 1 has been amended to more clearly point out the claimed subject matter.

Particularly, claim 1 has been amended to recite a gallium nitride compound semiconductor

light-emitting device comprising a substrate, an n-type semiconductor layer provided atop the

substrate, a light-emitting layer provided atop the n-type semiconductor layer, a p-type

semiconductor layer provided atop the light-emitting layer, a negative electrode provided in

contact with the n-type semiconductor layer, and a positive electrode provided in contact with

the p-type semiconductor layer, the n-type semiconductor layer, the light-emitting layer and the

p-type semiconductor layer being composed of a gallium nitride compound semiconductor.

Claim 1 has been further amended to incorporate therein the recitation of claim 8.

Claims 9-11 have been amended to depend from claim 1.

No new matter has been added. Entry of the Amendment is respectfully requested.

I. Drawing Objection

The Examiner objected to the drawings to under 37 C.F.R. § 1.83(a) as not showing the

contact metal layer and a positive-electrode-metal-containing layer as described in the

specification.

In response to the drawing objection, a replacement drawing sheet (Figure 2) is submitted

herewith to show a contact metal layer and a positive-electrode-metal-containing layer including

identifying reference numbers. Figure 2 also shows a semiconductor-metal-containing layer,

which is described in the original claim 8.

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Due to addition of the replacement drawing sheet of Figure 2, replacement sheets for Figures 1 and 3-7 are necessary and submitted herewith solely for the purpose of labeling the drawings with correct pagination (i.e., changing the drawing sheet pagination from "1/6-6/6" to "1/7-7/7").

No new matter has been added.

Withdrawal of the drawing objection and acceptance of the new drawing sheet are respectfully requested.

II. Claim Rejection under 35 U.S.C. §112

Claims 1-16 were rejected under 35 U.S.C. §112, second paragraph, as allegedly being indefinite. The Examiner asserted that it is unclear what the preamble of claim 1 is, and that the recited limitation of "the layers being successively provided atop the substrate in this order" is unclear as to which layers and which order Applicants are referring to.

In the accompanying amendments, claim 1 has been amended to recite a gallium nitride compound semiconductor light-emitting device comprising a substrate, an n-type semiconductor layer provided atop the substrate, a light-emitting layer provided atop the n-type semiconductor layer, a p-type semiconductor layer provided atop the light-emitting layer, a negative electrode provided in contact with the n-type semiconductor layer, and a positive electrode provided in contact with the p-type semiconductor layer, the n-type semiconductor layer, the light-emitting layer and the p-type semiconductor layer being composed of a gallium nitride compound semiconductor.

Applicants respectfully submit that the amendments to claim 1 render the rejection under 35 U.S.C. § 112, second paragraph moot and request the rejection be withdrawn.

III. Claim Rejections under 35 U.S.C. § 102/§103 Over Onomura

Claims 1-2, 4, 5, 8-9, 12 and 14-15 were rejected under 35 U.S.C. §102(b) as

being anticipated by Onomura et al (US 6,067,309).

Claims 3, 5, 7, 10-11 and 13 were rejected under 35 U.S.C. § 103(a) as being

unpatentable over Onomura.

Applicants respectfully traverse the above rejections.

The Examiner contends that Fig. 1 of Onomura discloses a gallium nitride compound

semiconductor light-emitting device including a substrate (1), an n-type semiconductor

layer (3+4), a light-emitting layer (6), a p-type semiconductor layer (7+8), a negative

electrode (14) provided in contact with the n-type semiconductor layer (3+4), and a positive

electrode (10+11a+11+12+13) provided in contact with the p-type semiconductor layer

(7+8), the layers being successively provided atop the substrate in this order and being

composed of a gallium nitride compound semiconductor (Fig. 1), wherein the positive

electrode (10+11a+11+12+13) includes at least a contact metal layer (10) which is in

contact with the p-type semiconductor layer (7+8); the contact metal layer (10) comprises at

least one metal selected from the group consisting of Pt; and the surface portion of the p-

type semiconductor layer (7+8) on the positive electrode side includes a positive-electrode-

metal-containing layer (15) that contains at least one metal selected from the group

consisting of Pt.

However, Onomura at least fails to disclose or suggest that the surface portion of the

contact metal layer on the p-type semiconductor layer side includes a semiconductor-metal-

containing layer that contains a Group III metal, as recited in amended claim 1.

Onomura also does not render obvious the presently claimed invention for the following reasons.

In the present invention, the semiconductor-metal-containing layer is a layer which is present in the contact metal layer and which contains a metal forming the semiconductor (see page 11, lines 26 to 30, of the present specification).

The Examiner asserts on page 5 of the Office Action that Onomura discloses a semiconductor-metal-containing layer (9). However, the layer (9) in Onomura is a p-type contact layer (see column 5, lines 48 to 59, of Onomura) and corresponds to the contact layer 5a of the present invention (see page 8, lines 21 to 30, of the present specification). Therefore, Onomura does not disclose or suggest a semiconductor-metal-containing layer, as required by present claim 1.

Further, in the present invention, the semiconductor-metal-containing layer and the positive-electrode-metal-containing layer may be formed by forming the contact metal layer through RF discharge sputtering and may be not formed in case of forming the contact metal layer through DC discharge sputtering (see Example 1, comparative Example and page 13, line 10 to page 14, line 4 of the present specification).

On the other hand, in Onomura, there is no description or suggestion regarding the formation method of a Pt layer 10 corresponding to the contact metal layer of the present invention. Onomura discloses that Pt is diffused to the p-type contact layer 9 by a thermal treatment at 350°C after forming the Pt layer 10. As a result, an alloy layer 15 of Pt-semiconductor, which corresponds to the positive-electrode-metal-containing layer of the present invention, is formed in the p-type contact layer 9 (see Fig. 1 and column 6, lines 34 to 42, of Onomura). Also, at the same time N is diffused from the p-type contact layer 9 to the Ti

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layer 11 on the Pt layer 10 and as a result the Ti layer lla containing TiN is formed. However,

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Onomura does not disclose that Ga is diffused from the p-type contact layer 9 to the Pt layer 10

and as a result a layer containing Ga, i.e., a metal forming the semiconductor, is formed in

the Pt layer 10.

Therefore, for these additional reasons, Onomura does not disclose or suggest the

semiconductor-metal-containing layer as required by amended claim 1.

Accordingly, Applicants respectfully submit that the present claims are patentable over

Onomura, and withdrawal of the foregoing rejections under 35 U.S.C. § 102 and §103 is

respectfully requested.

IV. Conclusion

In view of the above, reconsideration and allowance of this application are now believed

to be in order, and such actions are hereby solicited. If any points remain in issue which the

Examiner feels may be best resolved through a personal or telephone interview, the Examiner is

kindly requested to contact the undersigned at the telephone number listed below.

The USPTO is directed and authorized to charge all required fees, except for the Issue

Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any

overpayments to said Deposit Account.

Respectfully submitted.

/Yan Lan/

Yan Lan

Registration No. 50,214

SUGHRUE MION, PLLC

Telephone: (202) 293-7060

Facsimile: (202) 293-7860

WASHINGTON OFFICE

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CUSTOMER NUMBER

Date: March 11, 2009

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Annotated Sheets Showing Changes

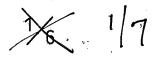
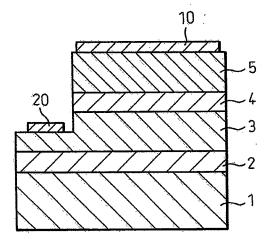
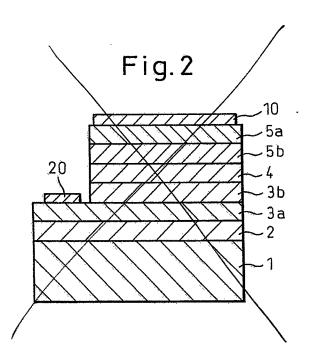
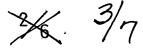


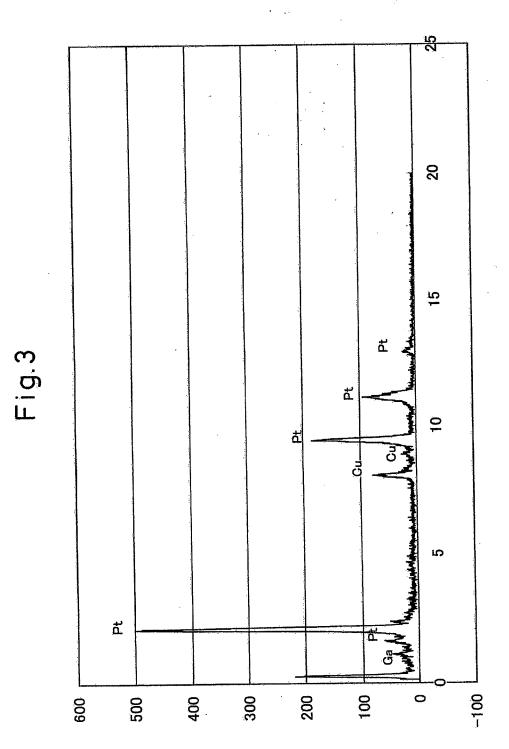
Fig.1



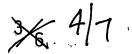


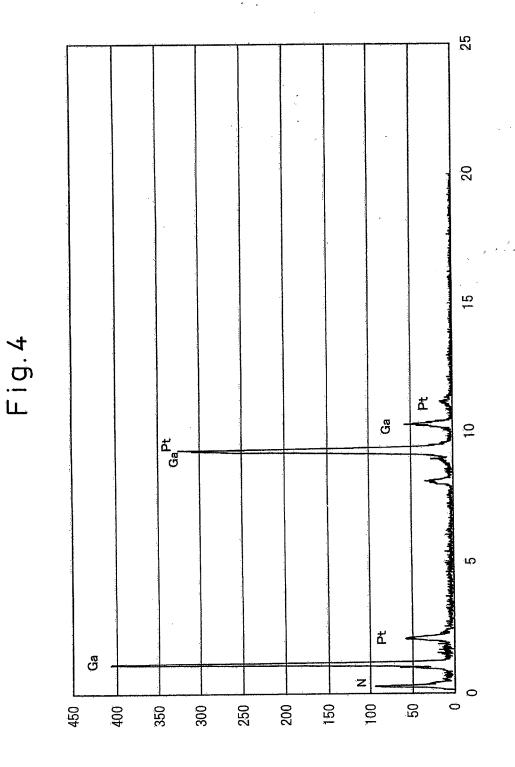
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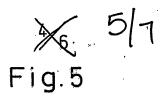


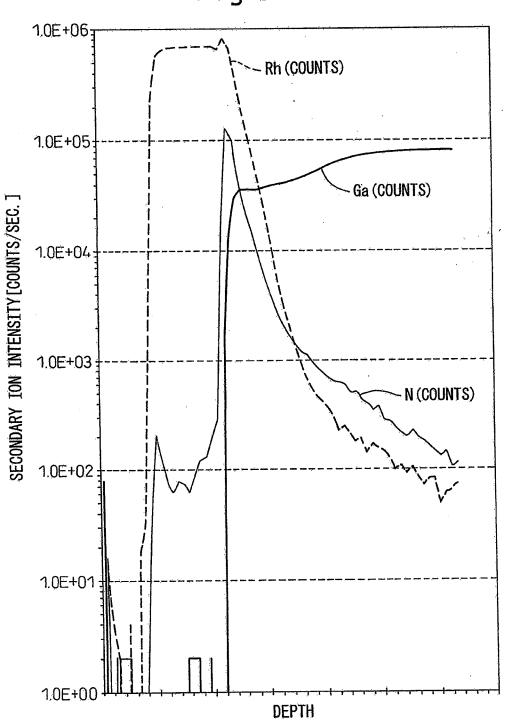
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